

# **BGE788C**

# 750 MHz, 34 dB gain push-pull amplifier Rev. 2 — 16 September 2011

Product data sheet

#### 1. **Product profile**

### 1.1 General description

Hybrid high dynamic range amplifier module operating at a supply voltage of 24 V (DC) in a SOT115J package. The module consists of two cascaded stages both in cascode configuration.

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- High gain
- Excellent return loss properties

### 1.3 Applications

■ Single module line extender in CATV systems operating in the 40 MHz to 750 MHz frequency range.

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	33.2	-	35.2	dB
		f = 750 MHz	33.5	-	-	dB
I <sub>tot</sub>	total current consumption	V <sub>B</sub> = 24 V	[ <u>1</u> ] 285	-	325	mA

[1] The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.



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# 2. Pinning information

Table 2. Pinning

Table 2.	i iiiiiiig	
Pin	Description	Simplified outline Symbol
1	input	
2	common	
3	common	
5	+V <sub>B</sub>	1 3 5 7 9
7	common	
8	common	sym095
9	output	

# 3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BGE788C	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J		

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_B$	supply voltage		-	25	V
Vi	RF input voltage		-	55	dBmV
T <sub>stg</sub>	storage temperature		-40	+100	°C
T <sub>mb</sub>	mounting base temperature		-20	+100	°C

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# 5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 750 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75 \Omega$ .

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$G_p$	power gain	f = 50 MHz	33.2	-	35.2	dB
		f = 750 MHz	33.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 750 MHz	0.3	-	2.3	dB
FL	flatness of frequency response	f = 40 MHz to 750 MHz	-	-	±0.6	dB
$ s_{11} ^2$	input return losses	f = 40 MHz to 320 MHz	16	-	-	dB
		f = 320 MHz to 640 MHz	15	-	-	dB
		f = 640 MHz to 750 MHz	14	-	-	dB
$ s_{22} ^2$	output return losses	f = 40 MHz to 320 MHz	16	-	-	dB
		f = 320 MHz to 640 MHz	15	-	-	dB
		f = 640 MHz to 750 MHz	14	-	-	dB
φs21	phase response	f = 50 MHz	135	-	225	deg
СТВ	composite triple beat	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 745.25 MHz	-	-	-49	dB
CSO	composite second order distortion	110 channels flat; V <sub>o</sub> = 44 dBmV; measured at 746.5 MHz	-	-	-52	dB
NF	noise figure	f = 50 MHz	-	-	8	dB
I <sub>tot</sub>	total current consumption		<u>[1]</u> 285	-	325	mA

<sup>[1]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

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# 6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

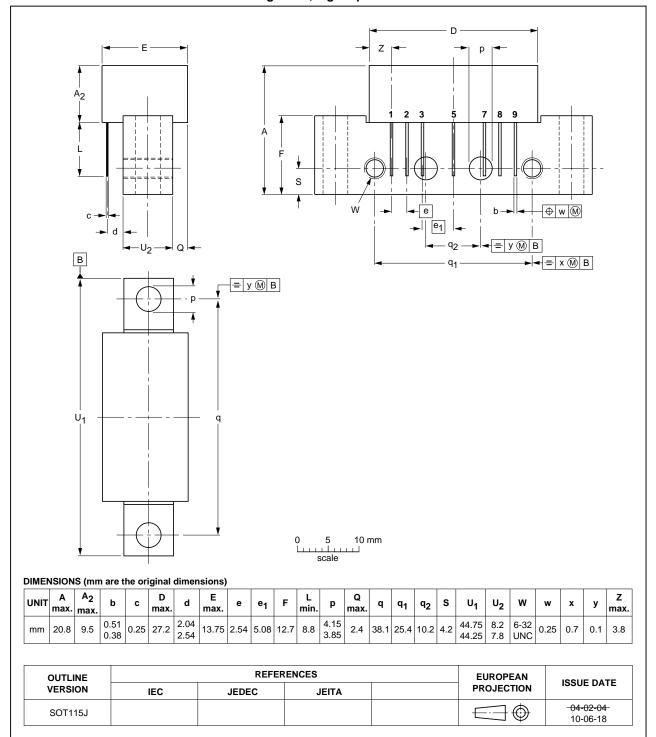


Fig 1. Package outline SOT115J

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# 7. Revision history

### Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGE788C v.2	20110916	Product data sheet	-	BGE788C v.1
Modifications:	guidelines of Legal texts	of this data sheet has been of NXP Semiconductors. have been adapted to the r utline drawings have been u	new company name whe	re appropriate.
BGE788C v.1 (9397 750 14607)	20050401	Product data sheet	-	-

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### 8. Legal information

### 8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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